

# Wiring, Printed - Flexible Material Constructions - Component

**COMPANY**

**BASELECTRON SRL**

Via Mons. Angelini 18  
San Martino Siccomario, PV 27028 Italy

E477015

Type	Cond Width		Min Cond Thk	SS/ DS/ DSO	Area Diam	Date After	Max Report	Surface Mount	Assembly Solder Process	Solder Limits	Max Oper Temp	Meets UL796F	C	T	I
	mm	mm													
<b>Multilayer flexible materials interconnect constructions (Flexible Application)</b>															
FM	0.09	0.09	12 Int:35	DS	50.8	No	-	-	-	288	20	105	V-0	-	-
<b>Multilayer Rigid Flex Composite, Flexible Materials Interconnect Constructions (Flexible Application)</b>															
RF	0.09	0.09	35 Int:35	DS	50.8	No	-	-	-	288	10	120	V-0	-	-
<b>Single layer flexible materials interconnect constructions(Flexible Application)</b>															
F	0.09	0.09	12	DS	50.8	No	-	-	-	288	20	105	V-0	-	-

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